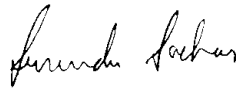


REMARKS

Favorable consideration of the present application is respectfully requested. Claims 1, 3-8, 13, and 14 are currently pending and are in condition for examination on the merits. An early and favorable action is respectfully requested.

Respectfully submitted,

OBLON, SPIVAK, McCLELLAND,
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IN THE SPECIFICATION

IN THE TITLE

Please amend the title as shown below:

SEMICONDUCTOR MODULE AND INSULATING SUBSTRATE [THEREFOR]
THEREOF